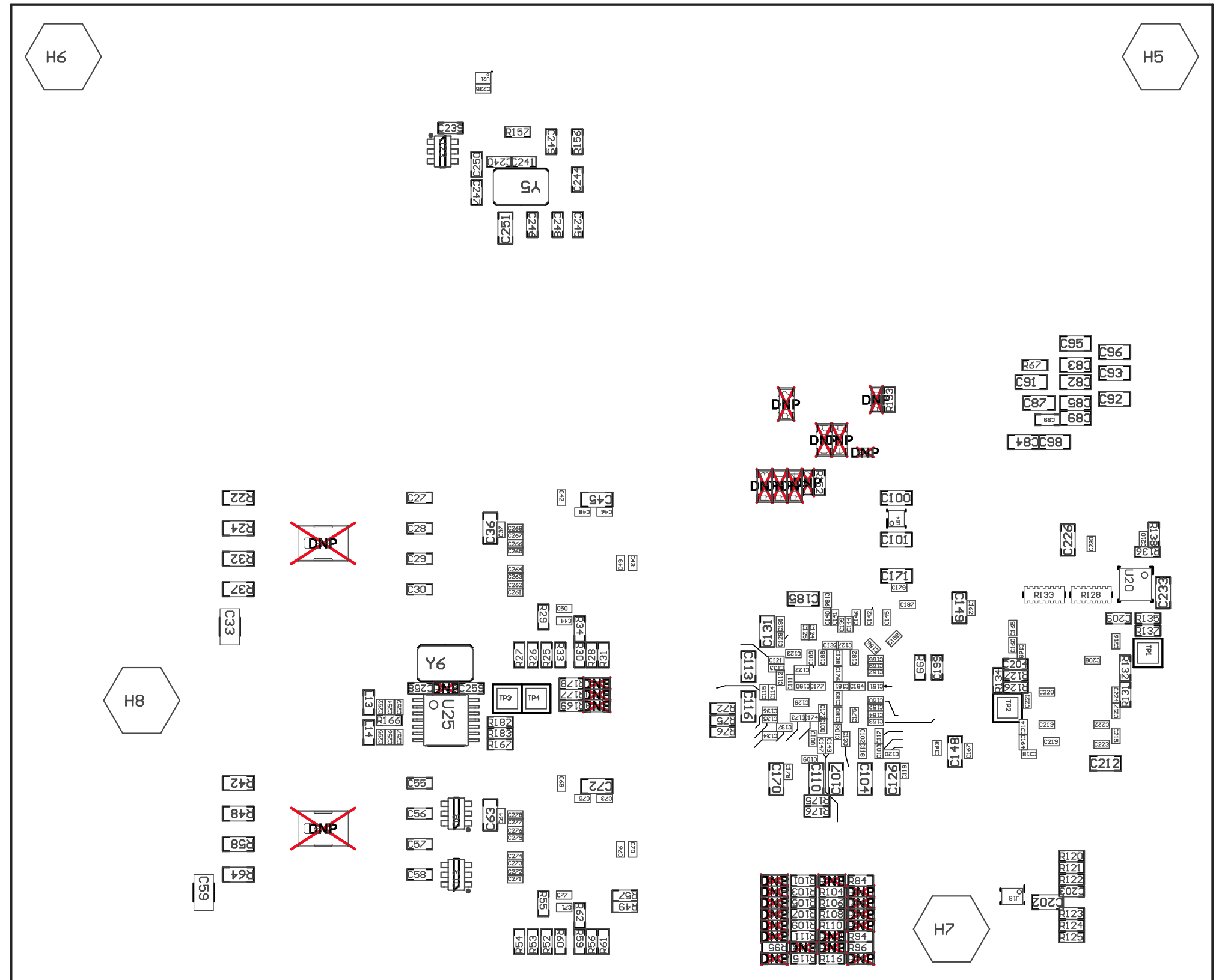


COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.  
 ASSEMBLY VARIANT: 002

PCB VIEWED FROM TOP SIDE	BOARD #: TIDA-00204	REV: E3	SUN REV: Not In VersionControl
M6pA8vembay Top			
PLOT NAME = Top Assembly Drawing	GENERATED : 6/14/2017	11:14:46 AM	TEXAS INSTRUMENTS



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.  
 ASSEMBLY VARIANT: 002

PCB VIEWED FROM BOTTOM SIDE	BOARD #: TIDA-00204	REV: E3	SUN REV: Not In VersionControl
mottos [unreadable]			
PLOT NAME = Bottom Assembly Drawing	GENERATED : 6/14/2017	11:14:49 AM	TEXAS INSTRUMENTS

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